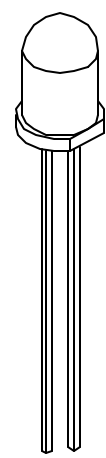
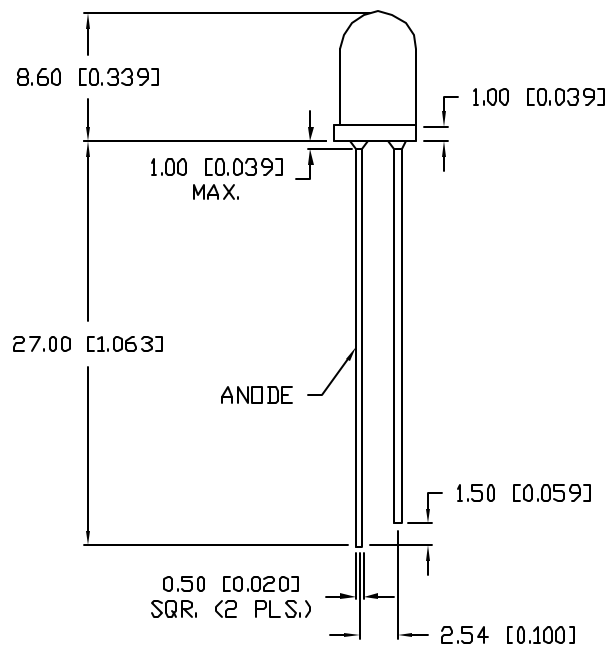
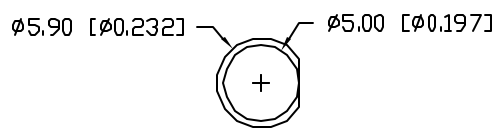


UNCONTROLLED DOCUMENT

PART NUMBER		REV.
SSL-LX5093SRC/X		D
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	UPDATED SPECS.	1.5.95
B	E.C.N. #10251.	9.30.96
C	E.C.N. #10BRDR. & REDRAWN IN 3D.	5.31.01
D	E.C.N. #10788.	9.13.01



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^{\circ}\text{C}$   $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		660		nm	
FORWARD VOLTAGE		1.7	2.2	$V_f$	
REVERSE VOLTAGE	4.0			$V_r$	$I_f=100\mu\text{A}$
AXIAL INTENSITY /DU	1000	1200		mcd	$I_f=20\text{mA}$
/DV	1300	1500		mcd	$I_f=20\text{mA}$
/DW	1600	1800		mcd	$I_f=20\text{mA}$
/E	2000	2800		mcd	$I_f=20\text{mA}$
/F	3500	4000		mcd	$I_f=20\text{mA}$
VIEWING ANGLE		30			2x theta
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	WATER CLEAR				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

\*  $t < 10\mu\text{s}$

REPLACES PART #: SSL-LX5093SRC(/B-/E)

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN= <sup>+0.00</sup>/<sub>-0.00</sub> DECIMAL PRECISION, MAX= <sup>+0.00</sup>/<sub>-0.00</sub> DECIMAL PRECISION

UNCONTROLLED DOCUMENT

REV.	PART NUMBER
D	SSL-LX5093SRC/X

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T-5mm (T-1 3/4) 660nm SUPER RED LED,  
 WATER CLEAR LENS.

**RELIABILITY NOTE**  
 OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE:
BC			2.9.93
			PAGE: 1 OF 1
			SCALE: N/A